ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Copyright 2005. IPC, Banno both international and Pan-Ame	ckburn, Illinois. All right	ts reserved under eng		parts, the	declaration	encompass	ses all lowe	er level mater	rials for wh	e: if the item is an assemb nich the manufacturer ha this declaration.				
1752-2 1.1	IPC Web Site for Informa http://www.ipc.org/IPC-		Standard		rm Type * stribute			laration Class * ss 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa							
Supplier Information															
Company Name *	Company Unique I	D Unique	e ID Authority	Resp	onse Date	e *	Response Document								
SEMTECH CORPORATIO	DN 00-847-9941	DUNS	3	2014	-05-26										
Contact Name *	Title - Contact	Phone	e - Contact *	Emai	il - Contac	t *				A 41 ·					
ROYA MOTAMEDI	QA CUSTOMER SE	RVICE SP 805-38	89-2742	rmot	amedi@se	emtech.co	m	Duplicate	Contact -:	> Authoriz	ed Representative				
Authorized Representati	ve * Title - Representativ	/e Phone	e - Representative	e * Emai	il - Repres	entative *	Supp	lier Comm	ents or URL	for Additio	onal Information				
ROYA MOTAMEDI	QA CUSTOMER SI	ERVICE SP 805-38	89-2742	rmot	amedi@se	emtech.co	m								
Requester Item Number	Mfr Item Number	Mfr Iten	m Name	Effect	ive Date	Version N	/anufacturir	ng Site	Weight *	UOM	Unit Type				
	SMS05C.TCT	300 Wa	att TVS Diode Arra	ay for E		С	hina		16.336	mg	Each				
Alternate Recommenda	ation					em Comme	o Comments								
Manufacturing Proces	ss Information			1											
Terminal Plating / Grid Array	Material	Terminal Base Allo	y J-STD-020	MSL Rating	Peak Proc	ess Body Te	emperature	Max Time	at Peak Temp	erature Nu	mber of Reflow Cycles				
Matte Tin (Sn) CU Allo			1			26	50 C		30 sec	conds 3					
Comments SMS05C.TCT is REACH	-compliant product, per	EU Regulation E	C1907/2006 to inc	clude recent	t addition	of SVHC c	andidate	list of sub	stances in [December	2013.				

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
RoHS Materia	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	town - town

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem			Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight		Tolerance		PPM	
		Name			Material	weight	Measure			Level	Substance Category			Substance		Exempt	weight	Measure	-	+	
+1 -	1	Die	+N	и-м	Doped silicon	0.5582	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		0.5582	mg			34,168
+1 -	1	_eadframe	+N	и-м	CDA194	6.94955	mg	+C	-C	Supplier		+S	-S	Cu	7440-50-8		6.6393	mg			406,42
												+S	-s	Fe	4939-89-6		0.1636	mg			10,015
												+S	-s	Р	7723-14-0		0.0055	mg			334
												+S	-s	Zn	7440-66-6		0.0082	mg			501
												+S	-s	Ag	7440-22-4		0.1331	mg			8,145
+I -	1	Bonding wire	+N	и-м	Gold wire	0.1191	mg	+C	-c	Supplier		+S	-s	Au	7440-57-5		0.1191	mg			7,288
+1 -	1	Molding compound	+N	и-м	CEL-1702HF9	7.7058	mg	+C	-C	Supplier		+S	-S	SiO2	60676-86-0		6.7272	mg			411,81
						•						+S	-s	Epoxy Resin	29690-82-2		0.3853	mg			23,586
												+S	-s	Phenol Resin	26834-02-6		0.3853	mg			23,586
												+S	-s	Aromatic poly-phospha	Proprietary		0.1926	mg			11,793
												+S	-s	С	1333-86-4		0.0154	mg			943
+I -	1	Die attached epoxy	+N	и-м	84-1LMISR4	0.22462	Img	+C	-c	Supplier		+S	-S	Ag	7440-22-4		0.1685	mg			10,313
												+S	-S	Epoxy resin	Proprietary		0.0449	mg			2,750
												+S	-s	Curing agent & hardene	Proprietary		0.0112	mg			688
+I -	1	Fin solder	+N	и-м	Pure tin	0.7784	mg	+C	-c	Supplier		+S	-S	Sn	7440-31-5		0.7784	mg			47,650